Low Power, High Sensitivity, I^{2}C Ambient Light Sensor

FEATURES

- Package type: surface-mount
- Dimensions (L x W x H in mm): 2.95 x 1.5 x 1.5
- Integrated modules: ambient light sensor (ALS)
- Supply voltage range V$_{DD}$: 2.6 V to 3.6 V
- Communication via I^{2}C interface
- I^{2}C bus H-level range: 1.7 V to 3.6 V
- Floor life: 168 h, MSL 3, according to J-STD-020
- Low stand by current consumption: typ. 1 µA
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free

e4

RoHS COMPLIANT

HALOGEN FREE GREEN (5-2008)

DESCRIPTION

VEML3235SL is an advanced ambient light sensor with I^{2}C protocol interface and is designed by the CMOS process. It is easy to operate via a simple I^{2}C command.

VEML3235SL incorporates a photodiode, amplifiers, and analog circuits in a single chip. The best spectral sensitivity is used to closely capture real human eye responses. VEML3235SL has excellent temperature compensation and the robust refresh rate setting does not need an external RC low pass filter. Software shutdown mode is provided, which reduces power consumption to be less than 1 µA. VEML3235SL's operating voltage ranges from 2.6 V to 3.6 V. VEML3235SL can detect a wide range of ambient light power.

APPLICATIONS

- Handheld device
- Notebook
- Consumer device
- Industrial and medical application
- Computing, and industrial devices and displays

AMBIENT LIGHT FUNCTION

- High ALS sensitivity with minimum detectable intensity of 0.0021 lx/cnt supports low transmittance lens design
- Excellent temperature compensation
- High dynamic detection resolution
- Software shutdown mode control

PRODUCT SUMMARY

PART NUMBER	OPERATING VOLTAGE RANGE (V)	I²C BUS VOLTAGE RANGE (V)	AMBIENT LIGHT RANGE (lx)	AMBIENT LIGHT RESOLUTION (lx)	OUTPUT CODE	ADC RESOLUTION PROXIMITY / AMBIENT LIGHT
VEML3235SL	2.6 to 3.6	1.7 to 3.6	0.0021 to 17 867	0.0021	16 bit, I²C	- / 16 bit

ORDERING INFORMATION

ORDERING CODE	PACKAGING	VOLUME [1]	REMARKS
VEML3235SL	Tape and reel	MOQ: 2500	2.95 mm x 1.5 mm x 1.5 mm

Note
[1] MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT
Supply voltage		V_{DD}	0	4	V
Operation temperature range		T_{amb}	-40	+85	°C
Storage temperature range		T_{stg}	-40	+85	°C

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V_{DD}	2.6	3.3	3.6	V
Shut down current [1][2]	V_{DD} is 3.3 V	I_{sd}	-	1	-	µA
Supply current [1]	V_{DD} is 3.3 V	I_{DD}	-	250	-	µA
I²C clock rate range		f_{SCL}	10	-	400	kHz
I²C bus input H-level range	V_{DD} is 3.3 V	V_{ih}	1.2	-	V_{DD}	V
I²C bus input L-level range	V_{DD} is 3.3 V	V_{il}	0	-	0.4	V
Digital resolution (LSB count) [2]	With DG = x 2, Gain = x 4		-	0.0021	-	lx/step
Detectable minimum illuminance [2]	With DG = x 2, Gain = x 4	$E_{V\,min.}$	-	0.0021	-	lx
Detectable maximum illuminance [3]	With DG = x 1, Gain = x 1	$E_{V\,max.}$	-	17 867	-	lx

Notes

[1] V_{DD} = 3.3 V, temperature: 25 °C
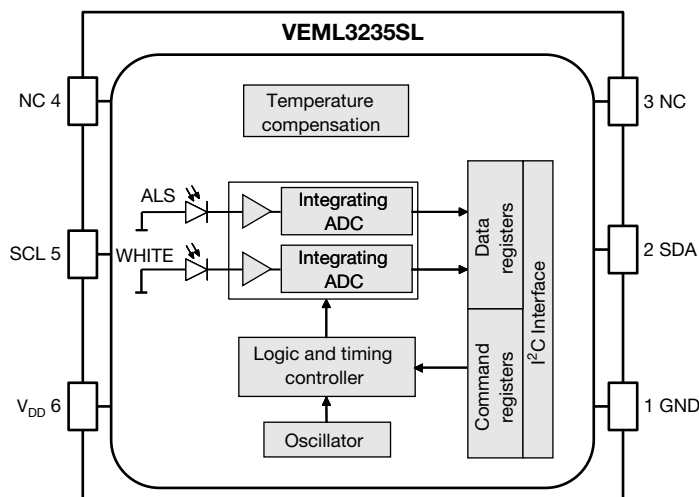
[2] IT = 800 ms

[3] IT = 50 ms

CIRCUIT BLOCK DIAGRAM

Fig. 1 - Block Diagram

I²C TIMING CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	SYMBOL	STANDARD MODE [1]		FAST MODE [1]		UNIT
		MIN.	MAX.	MIN.	MAX.	
Clock frequency	$f_{(SMBCLK)}$	10	100	10	400	kHz
Bus free time between start and stop condition	$t_{(BUF)}$	4.7	-	1.3	-	µs
Hold time after (repeated) start condition; after this period, the first clock is generated	$t_{(HDSTA)}$	4.0	-	0.6	-	µs
Repeated start condition setup time	$t_{(SUSTA)}$	4.7	-	0.6	-	µs
Stop condition setup time	$t_{(SUSTO)}$	4.0	-	0.6	-	µs
Data hold time	$t_{(HDDAT)}$	-	3450	-	900	ns
Data setup time	$t_{(SUDAT)}$	250	-	100	-	ns
I²C clock (SCL) low period	$t_{(LOW)}$	4.7	-	1.3	-	µs
I²C clock (SCL) high period	$t_{(HIGH)}$	4.0	-	0.6	-	µs
Clock / data fall time	$t_{(F)}$	-	300	-	300	ns
Clock / data rise time	$t_{(R)}$	-	1000	-	300	ns

Note

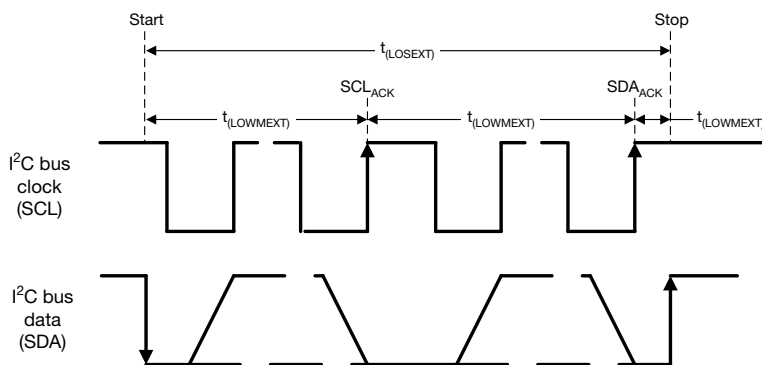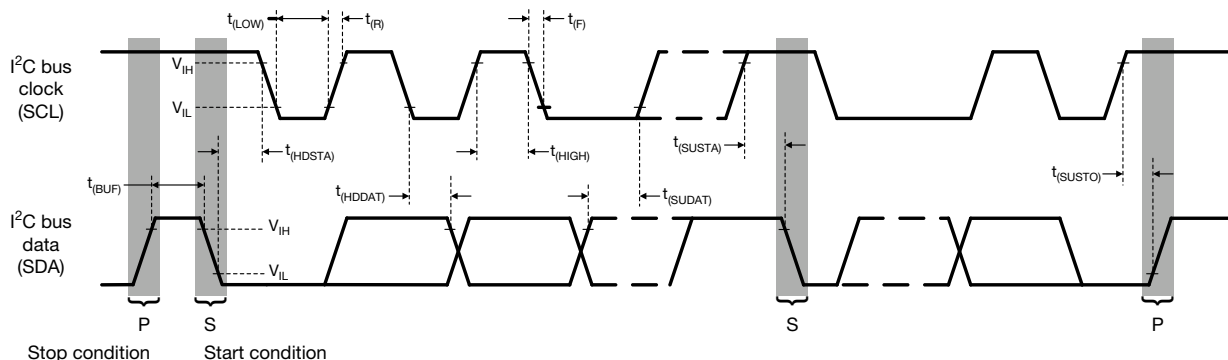[1] Data based on standard I²C protocol requirement, not tested in production

Fig. 2 - I²C Timing Diagram
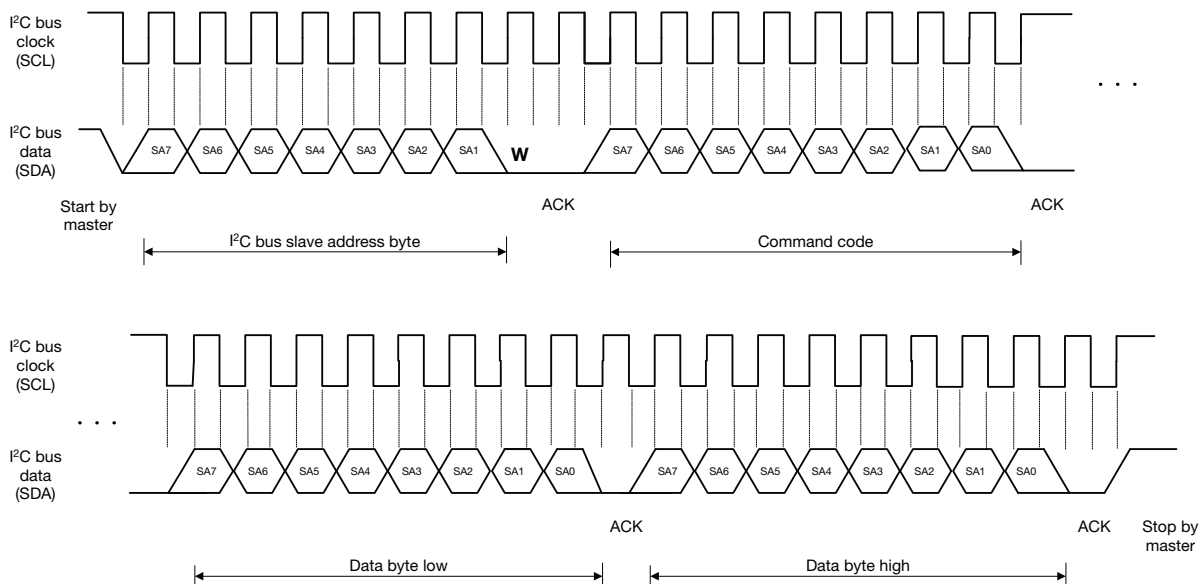
PARAMETER TIMING INFORMATION
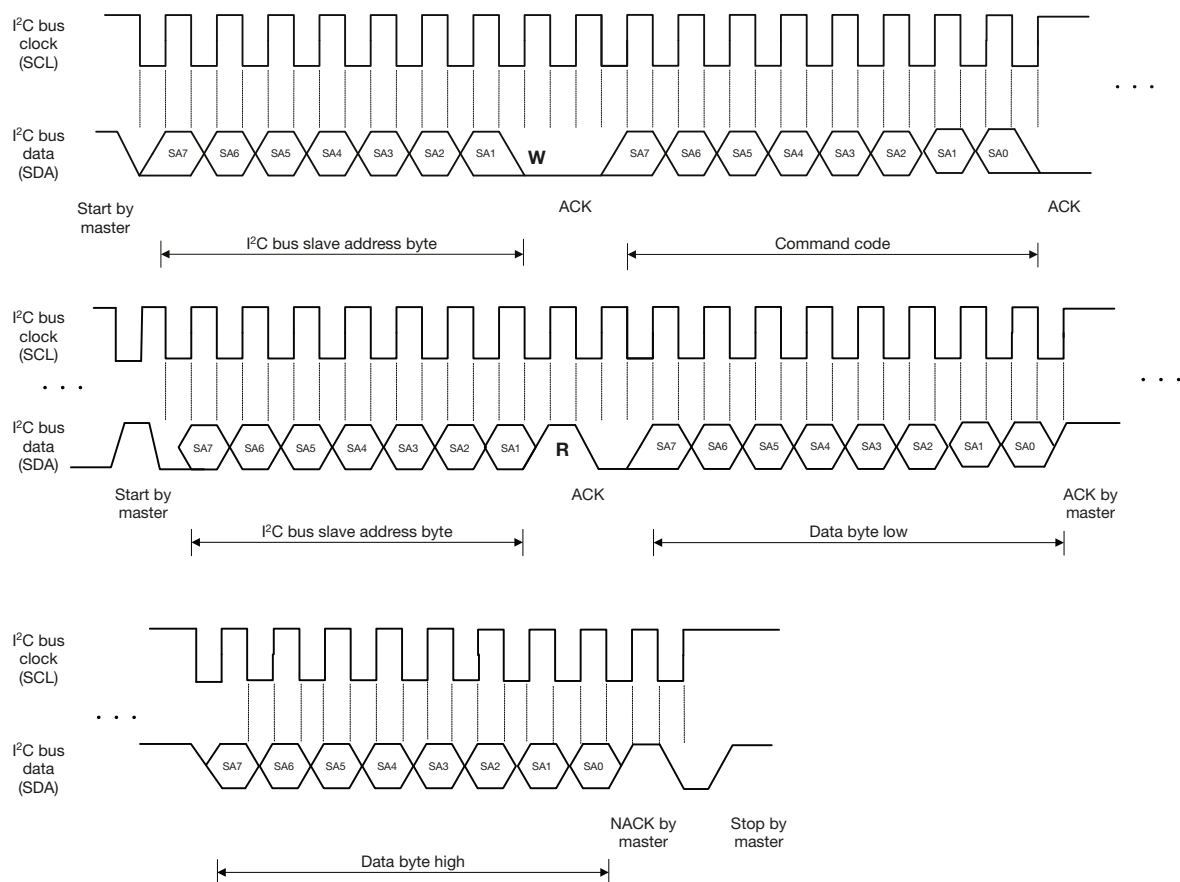
Fig. 3 - I²C Bus Timing for Sending Word Command Format
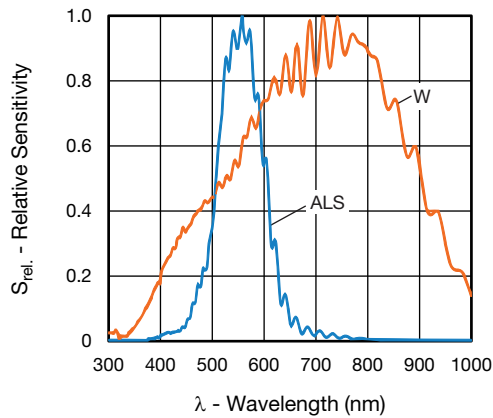
Fig. 4 - I²C Bus Timing for Receive Word Command Format

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

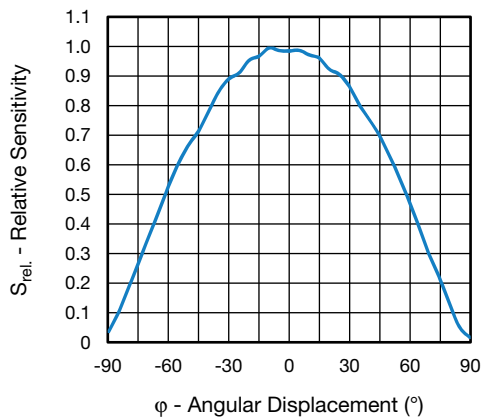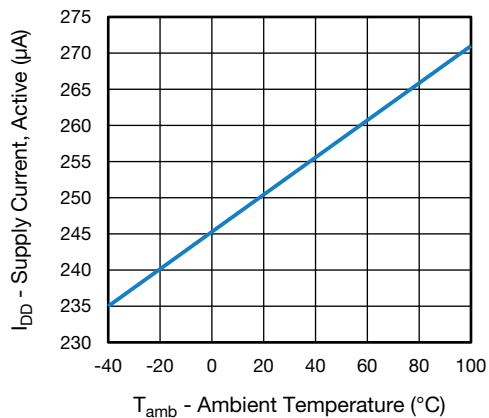Fig. 6 - Relative Sensitivity vs. Angular Displacement

Fig. 7 - Supply Current vs. Ambient Temperature

For technical questions, contact: consumersensors@vishay.com

APPLICATION INFORMATION

1. Pin Connection With the Host

VEML3235SL is a cost effective solution with I²C interface. The standard serial digital interface easily accesses "light intensity" without using complex calculations and programming by an external controller.

The additional capacitor near the V_{DD} pin in the circuit is used for power supply noise rejection. The value is recommended at 0.1 µF. The pull-high resistors for the I²C bus design are recommended to be 2.2 kΩ.
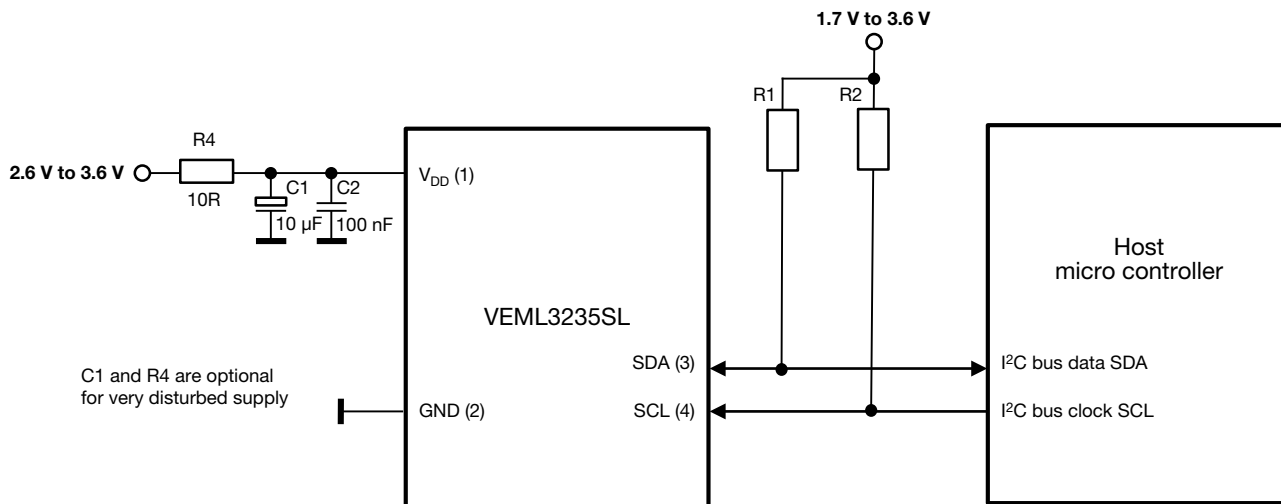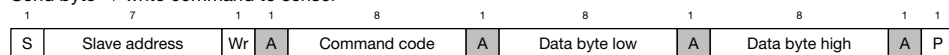

Fig. 8 - Hardware Pin Connection Diagram (Slave Address 0x10)
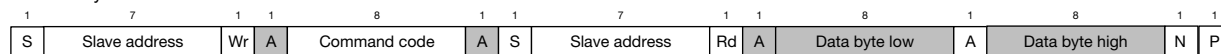
Digital Interface

VEML3235SL contains a command register written via the I²C bus. All operations can be controlled by the command register. The simple command structure allows the user to easily program the operation setting and latch the light data from VEML3235SL. VEML3235SL's I²C command format description for read and write operations between VEML3235SL and the host is shown in Fig. 9. The white areas indicate the host activity and the gray areas indicate VEML3235SL's acknowledgement of the host access activity.

Send byte → write command to sensor

1	7	1	1	8	1	8	1	8	1	1
S	Slave address	Wr	A	Command code	A	Data byte low	A	Data byte high	A	P

Receive byte → read data from VEML3235SL

1	7	1	1	8	1	1	7	1	1	8	1	8	1	1
S	Slave address	Wr	A	Command code	A	S	Slave address	Rd	A	Data byte low	A	Data byte high	N	P

S = start condition
P = stop condition
A = acknowledge
N = not acknowledge

☐ Host action

▨ Sensor acknowledge

Fig. 9 - Command Protocol Format

Command Register Format

VEML3235SL uses 0x10 slave address for 7-bit I^{2}C addressing protocol. VEML3235SL has 16-bit resolution for each channel (ALS and W).

TABLE 1 - COMMAND CODE DESCRIPTION					
COMMAND CODE	**REGISTER NAME**	**DATE BYTE LOW / HIGH**	**BIT**	**FUNCTION DESCRIPTION**	**R / W**
0x00	Reserved	L	7	Set 0	R / W
	ALS/W_IT		6 : 4	ALS/W integration time setting (0 : 0 : 0) = 50 ms (0 : 0 : 1) = 100 ms (0 : 1 : 0) = 200 ms (0 : 1 : 1) = 400 ms (1 : 0 : 0) = 800 ms	
	Reserved		3 : 1	Set 0	
	SD		0	Shutdown BG and LDO with SD = 1 (default)	
	SD0	H	7	Shutdown ALS and white channel with SD0 = 1 (default)	
	Reserved		6	Set 0	
	DG		5	0 = x 1, 1 = x 2	
	Gain		4 : 3	(0 : 0) = x 1 (0 : 1) = x 2 (1 : 0) = reserved (1 : 1) = x 4	
	Reserved		2 : 1	Set 0	
	Reserved		0	Set 1	
0x02	Reserved	L	7 : 0	Set 0	
	Reserved	H	7 : 0	Set 0	
0x04	W_LSB	L	7 : 0	W LSB data	R
	W_MSB	H	7 : 0	W MSB data	
0x05	ALS_LSB	L	7 : 0	ALS LSB data	
	ALS_MSB	H	7 : 0	ALS MSB data	
0x09	ID_L	L	7 : 0	ID part number: 3235 = 0011 0101	
	Reserved	H	7 : 0	Reserved	

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Data Access

VEML3235SL has 16-bit high resolution sensitivity for each channel. To represent the 16-bit data, it has to apply two bytes. One byte is for LSB and the other byte is for MSB. The host needs to follow the read word protocol. The data format shows as below.

TABLE 2 - 16-BIT DATA FORMAT																
	VEML3235SL 16-BIT DATA FORMAT															
Data bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Data byte low									←——————————————————→							
Data byte high	←——————————————————→															

Note

S	Slave address	Wr	A	Command code	A	S	Slave address	Rd	A	Data byte low	A	Data byte high	N	P

- Data byte low represents LSB and data byte high represents MSB

The table below shows these dependencies:

RESOLUTION AND MAXIMUM DETECTION RANGE AT DG = 1							
	GAIN: x 4	GAIN: x 2	GAIN: x 1		GAIN: x 4	GAIN: x 2	GAIN: x 1
IT (ms)	TYPICAL RESOLUTION (lx/cnt)				MAXIMUM POSSIBLE ILLUMINATION (lx)		
800	0.00426	0.00852	0.01704		279	558	1117
400	0.00852	0.01704	0.03408		558	1117	2233
200	0.01704	0.03408	0.06816		1117	2233	4467
100	0.03408	0.06816	0.13632		2233	4467	8934
50	0.06816	0.13632	0.27264		4467	8934	17 867

RESOLUTION AND MAXIMUM DETECTION RANGE AT DG = 2							
	GAIN: x 4	GAIN: x 2	GAIN: x 1		GAIN: x 4	GAIN: x 2	GAIN: x 1
IT (ms)	TYPICAL RESOLUTION (lx/cnt)				MAXIMUM POSSIBLE ILLUMINATION (lx)		
800	0.00213	0.00426	0.00852		140	279	558
400	0.00426	0.00852	0.01704		279	558	1117
200	0.00852	0.01704	0.03408		558	1117	2233
100	0.01704	0.03408	0.06816		1117	2233	4467
50	0.03408	0.06816	0.13632		2233	4467	8934

Example:

If the 16-bit word of the ALS data shows: 0000 0101 1100 1000 = 1480 (dec.), the programmed Gain = x 1, the digital gain DG = x 1 and the integration time is 100 ms, the corresponding lux level is: light level [lx] = 1480 x 0.13632 = 202 lx.

For detailed description about set-up and more application related information see application note: "Designing VEML3235SL into an Application".
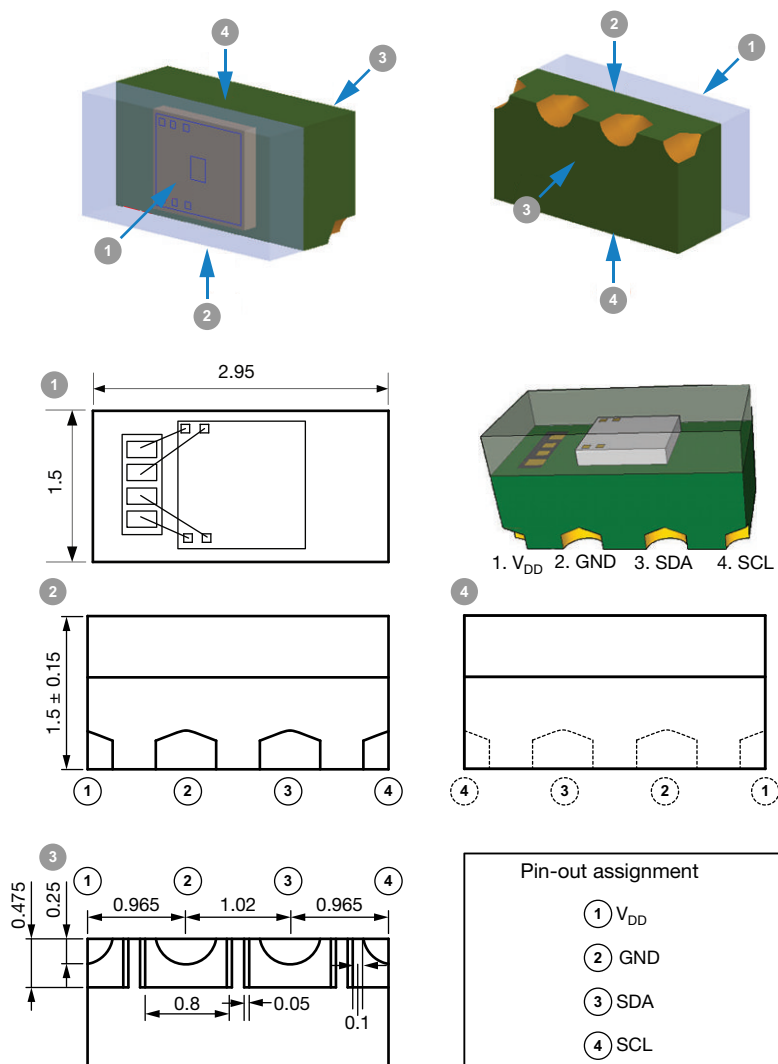
PACKAGE INFORMATION in millimeters

1. V$_{DD}$ 2. GND 3. SDA 4. SCL

Pin-out assignment

1 V$_{DD}$
2 GND
3 SDA
4 SCL

Fig. 10 - VEML3235SL Package Dimensions

1. V$_{DD}$ 2. GND   3. SDA   4. SCL
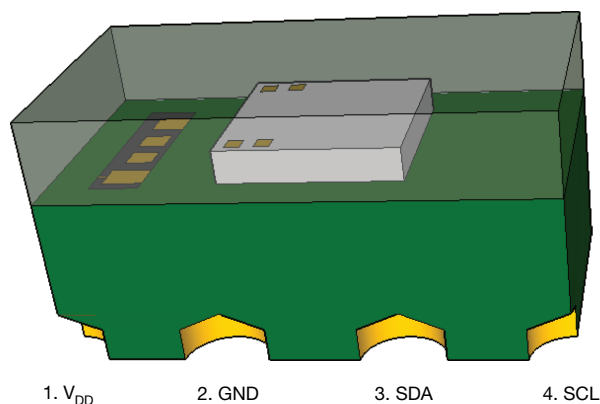
Fig. 11 - VEML3235SL Package Dimensions

LAYOUT NOTICE AND REFERENCE CIRCUIT in millimeters

Pad and Circuit Layout Reference

Recommended footprint
Package edge to edge
2.95
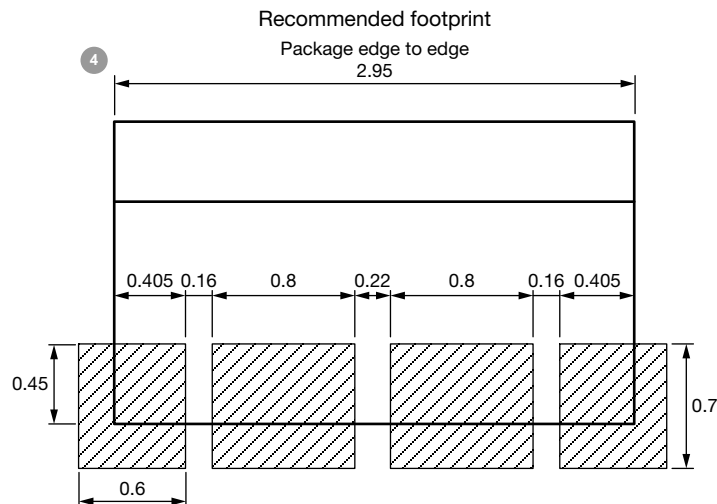
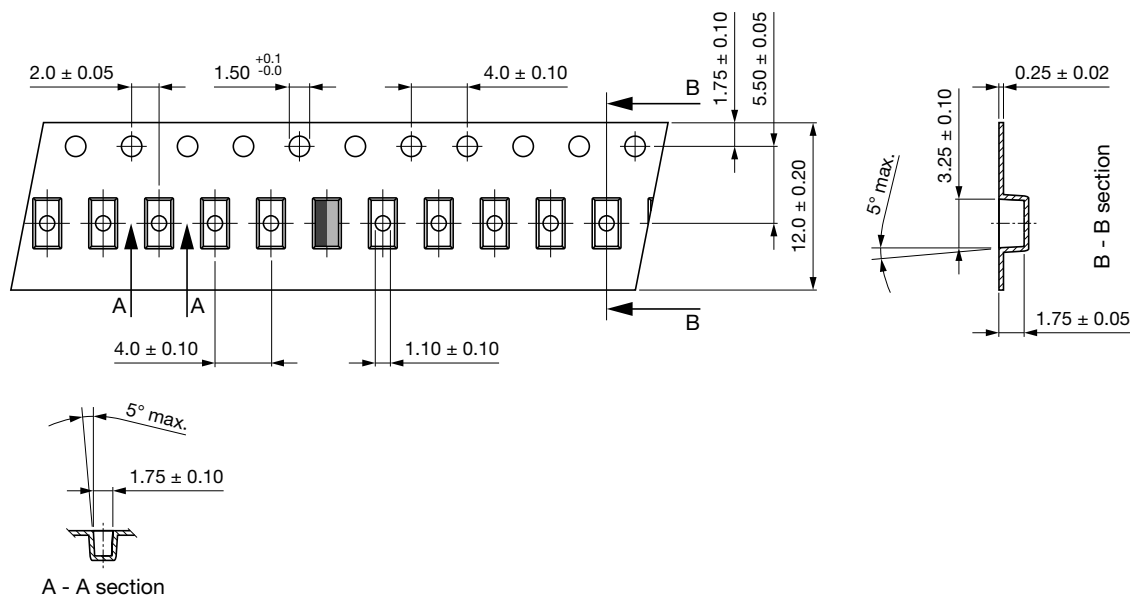Fig. 12 - VEML3235SL PCB Layout Footprint

TAPE AND REEL DIMENSIONS in millimeters
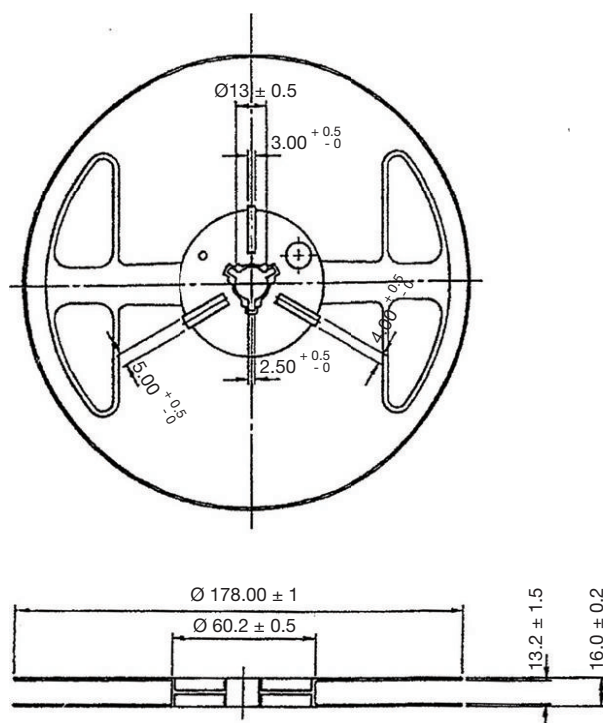

A - A section

Fig. 13 - VEML3235SL Package Carrier Tape

Fig. 14 - Reel Dimension

RECOMMENDED STORAGE AND REBAKING CONDITIONS				
PARAMETER	**CONDITIONS**	**MIN.**	**MAX.**	**UNIT**
Storage temperature		5	50	°C
Relative humidity		-	60	%
Open time		-	168	h
Total time	From the date code on the aluminized envelope (unopened)	-	12	months
Rebaking	Tape and reel: 60 °C	-	22	h
	Tube: 60 °C	-	22	h

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RECOMMENDED INFRARED REFLOW

Soldering conditions which are based on J-STD-020 C

IR REFLOW PROFILE CONDITION			
PARAMETER	**CONDITIONS**	**TEMPERATURE**	**TIME**
Peak temperature		255 °C + 0 °C / - 5 °C (max.: 260 °C)	10 s
Preheat temperature range and timing		150 °C to 200 °C	60 s to 180 s
Timing within 5 °C to peak temperature		-	10 s to 30 s
Timing maintained above temperature / time		217 °C	60 s to 150 s
Timing from 25 °C to peak temperature		-	8 min (max.)
Ramp-up rate		3 °C/s (max.)	-
Ramp-down rate		6 °C/s (max.)	-

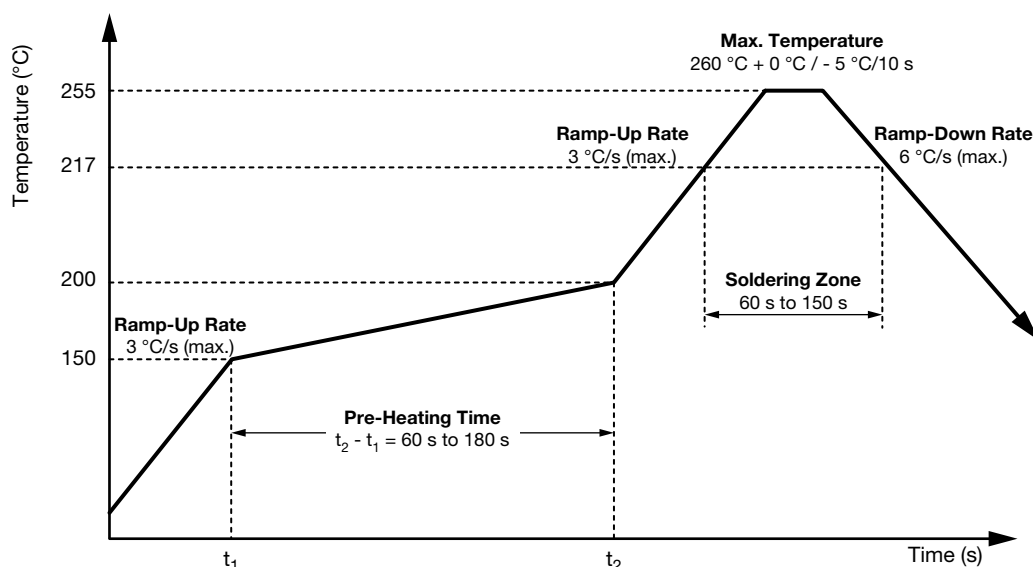Recommend Normal Solder Reflow is 235 °C to 255 °C

Fig. 15 - VEML3235SL Solder Reflow Profile Chart

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

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